

RPP M20 NXC

PPCP, 20% mineral filled, flame retardant – halogen (RoHS compliant), heat stabilized, natural

Property (dry as molded)				
General Properties	Condition	Value	Unit	Standard
Abbreviation	-	PP MD20 FR(15)	-	ISO 1043
Density	-	1,09	g/cm ³	ISO 1183
Melt Flow Rate	2.16kg, 230 °C	15	g/10'	ISO 1133
Molding Shrinkage	Parallel / Normal	-	%	ISO 15512
Moisture Content	-	-	%	ISO 15512
Moisture Absorption	50% RH, 23 °C	-	%	ISO 62
Mechanical Properties	Condition	Value	Unit	standard
Stress at Break	+23 °C	25	MPa	ISO 527
Strain at Break	+23 °C	40.0	%	ISO 527
Tensile Modulus	+23 °C	2250	MPa	ISO 527
Yield Strength	+23 °C	-	MPa	ISO 527
Izod Impact, notched	+23 °C	10	kJ/m ²	ISO 180/1A
Izod Impact, notched	-30 °C	4	kJ/m ²	ISO 180/1A
Izod Impact, un-notched	+23 °C	75	kJ/m ²	ISO 180/1U
Izod Impact, un-notched	-30 °C	-	kJ/m ²	ISO 180/1U
Thermal Properties	Condition	Value	Unit	Standard
Melting Temperature	10 K/min	160 - 165	°C	ISO 11357
Heat Deformation Temperature	0.45 MPa	-	°C	ISO 75
Heat Deformation Temperature	1.80 MPa	55	°C	ISO 75
Vicat Softening Temperature	50N	145	°C	ISO 306
Electrical Properties & Flammability	Condition	Value	Unit	Standard
Volume Resistivity	-	1E+15	Ohm.cm	IEC 60093
Surface Resistivity	-	1E+15	Ohm	IEC 60093
Comparative Tracking Index	Solution A	-	V	IEC 60112
Glow Wire Flammability Index (GWFI)	2 mm plaque	850	°C	IEC 60695
Glow Wire Ignitability Temperature (GWIT)	2 mm plaque	775	°C	IEC 60695
Flame Rating	0.75 mm	V2	-	UL 94
Flame Rating	1.6 mm	V2	-	UL 94
Processing Parameters	Condition	Value	Unit	Standard
Drying	-	-	°C /hr	
Feed Throat Temperature	-	<60	°C	
Processing Temperature	-	200 – 240	°C	
Mold Temperature	-	20 – 50	°C	
Hold Pressure	-	40 – 80	MPa	
Back Pressure	-	Low	-	
Injection Speed	-	Medium - Fast	-	

All above information are gathered under the supervision of ReMo Polytechnic Company in laboratories. For sure there is no guarantee due to various test result under different condition process. As result this is the end users responsibilities and duties to test our products under their required processing condition, uses and by their own facilities.